

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	345	438/464.ccls. and @ad<="20020902"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 13:55
L3	10	438/464.ccls. and @ad<="20020902" and isotropic and anisotropic	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 13:21
L4	491	semiconductor and dic\$3 and anisotropic and isotropic and etch and @ad<="20020902"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/01 14:48
L5	1	@pn="6247790"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/01 14:48
S1	970	438/123.ccls. and @ad<="20020902"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 08:41
S2	16	S1 and "cutting portion"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/02/22 13:15
S3	1777	wafer adj dicing	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/02/22 13:16
S4	1495	semiconductor and wafer adj dicing	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/02/22 13:16
S5	283	semiconductor and (wafer adj dicing).ab.	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/02/22 13:17
S6	242	S5 and @ad<="20020902"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/02/22 13:23
S7	16	S6 and etch	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/02/22 13:55

S8	528	438/460.ccls. and @ad<="20020902"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 08:55
S9	169	S8 and etch	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/02/22 14:30
S10	2	"4729971".pn.	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/02/22 14:22
S11	5	S9 and rounded adj corner	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 08:54
S12	27	438/460.ccls. and laser adj cutting	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/02/24 14:14
S13	54	438/460.ccls. and laser.ab.	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/02/24 14:14
S14	279	@ad<="20020902" and (resist photoresist) near3 (rounded)	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 08:43
S15	2	@pn="6,057,081"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 08:44
S16	1	@pn="6057081"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 08:44
S17	528	438/460.ccls. and @ad<="20020902"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 08:54
S18	169	S17 and etch	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 08:54
S19	1	S18 and ((resist photoresist) near3 rounded)	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 08:54

S20	1	438/460.ccls. and @ad<="20020902" and ((resist photoresist) near3 rounded)	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 08:55
S21	1	438/460.ccls. and @ad<="20020902" and ((resist photoresist) near3 round\$3)	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 11:01
S22	1	@pn="4325182"	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2005/04/01 10:46
S23	1	@pn="5998238"	US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB	OR	ON	2005/04/01 10:46
S24	528	438/460.ccls. and @ad<="20020902"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 13:20
S25	11	438/460.ccls. and @ad<="20020902" and isotropic and anisotropic	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2005/04/01 13:21